

Declaration and Power of Attorney For Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled PRINTED WIRING BOARD-FORMING SHEET, VIA HOLE-FORMING METHOD, RESIN SHEET HAVING FILLED VIA HOLE, PRINTED WIRING BOARD, AND PROCESS FOR PRODUCING THE SAME, the specification of which

(check one)

☒ is attached hereto.

☒ was filed on May 1, 2000 as

Application Serial No. PCT/JP00/02879

and was amended on _____ (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
144275/1999	Japan	25/May/1999	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)		
_____	_____	_____	<input type="checkbox"/> Yes	<input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)		
_____	_____	_____	<input type="checkbox"/> Yes	<input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)		

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

William H. Logsdon	22,132	Barbara E. Johnson	31,198	Lester N. Fortney	38,141
Russell D. Orkin	25,363	Paul M. Reznick	33,059	Randall A. Notzen	36,882
David C. Hanson	23,024	John W. McIlvaine	34,219	Jesse A. Hirshman	40,016
Frederick B. Ziesenheim	19,438	Michael I. Shamos	30,424	James G. Porcelli	33,757
Richard L. Byrne	28,498	Blynn L. Shideler	35,034	Kent E. Baldauf, Jr.	36,082
Kent E. Baldauf	25,825	Julie W. Meder	36,216		

Send Correspondence to:
Russell D. Orkin, 700 Koppers Building, 436 Seventh Avenue, Pittsburgh PA 15219-1818

Direct Telephone calls to: (name and telephone number) Russell D. Orkin (412) 471-8815

Full name of sole or first inventor

Toshiyuki NAKAMURA

Inventor's signature

Toshiyuki Nakamura

Date

Dec. 20, 2000

Residence

Suzaka-shi, Nagano, Japan

Citizenship

Japanese

Post Office Address

c/o SUZUKI CO., LTD., 2150-1, Oaza Ogawara, Suzaka-shi, Nagano

382-8588, Japan

Full name of second joint inventor, if any

Hideto TANAKA

Second inventor's signature

Hideto Tanaka

Date

Dec. 20, 2000

Residence

Suzaka-shi, Nagano, Japan

Citizenship

Japanese

Post Office Address

c/o SUZUKI CO., LTD., 2150-1, Oaza Ogawara, Suzaka-shi, Nagano

382-8588, Japan

(Supply similar information and signature for third and subsequent joint inventors.)

Full name of third joint inventor, if any <u>Akira ICHIRYU</u>		
Third inventor's signature	<u>Akira Ichiryu</u>	Date Dec. 20, 2000
Residence	<u>Ageo-shi, Saitama, Japan</u>	
Citizenship	Japanese	
Post Office Address	c/o MITSUI MINING & SMELTING CO., LTD. Corporate R & D Center, 1333-2, Haraichi, Ageo-shi, Saitama 362-0021, Japan	
Full name of fourth joint inventor, if any <u>Motonobu TAKAHASHI</u>		
Fourth inventor's signature	<u>Motonobu Takahashi</u>	Date Dec. 20, 2000
Residence	<u>Ageo-shi, Saitama, Japan</u>	
Citizenship	Japanese	
Post Office Address	c/o MITSUI MINING & SMELTING CO., LTD. Corporate R & D Center, 1333-2, Haraichi, Ageo-shi, Saitama 362-0021, Japan	
Full name of fifth joint inventor, if any <u>Masahito ISHII</u>		
Fifth inventor's signature	<u>Masahito Ishii</u>	Date Dec. 20, 2000
Residence	Japanese	
Citizenship	<u>Hino-shi, Tokyo, Japan</u>	
Post Office Address	4-19-15, Higashi Toyoda, Hino-shi, Tokyo 191-0052, Japan	
Full name of sixth joint inventor, if any <u>Daisuke ARAI</u>		
Sixth inventor's signature	<u>Daisuke Arai</u>	Date Dec. 20, 2000
Residence	<u>Ageo-shi, Saitama, Japan</u>	
Citizenship	Japanese	
Post Office Address	c/o MITSUI MINING & SMELTING CO., LTD. Corporate R & D Center, 1333-2, Haraichi, Ageo-shi, Saitama 362-0021, Japan	